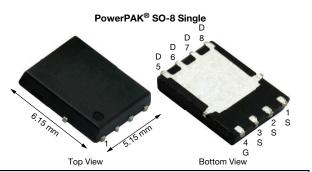
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RoHS COMPLIANT

HALOGEN

FREE



PRODUCT SUMMARY						
V _{DS} (V)	30					
$R_{DS(on)}$ max. (Ω) at V_GS = 10 V	0.00683					
$R_{DS(on)}$ max. (Ω) at V_GS = 4.5 V	0.01050					
Q _g typ. (nC)	6.2					
I _D (A) ^a	40					
Configuration	Single					

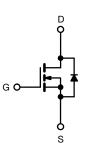
FEATURES

N-Channel 30 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- High power density DC/DC
- Synchronous rectification
- Power conversion
- · Load switch



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiRA88BDP-T1-GE3

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unless	s otherwise no [.]	ted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	30	V	
Gate-source voltage		V _{GS}	+20, -16	v	
	T _C = 25 °C		40		
Continuous drain current ($T_J = 150 \ ^\circ C$)	T _C = 70 °C		32		
	T _A = 25 °C	I _D	19 ^{b, c}		
	T _A = 70 °C		15 ^{b, c}	А	
Pulsed drain current (t = 100 μs)		I _{DM}	90	7 ^	
Continuous source-drain diode current	T _C = 25 °C	1	16		
Continuous source-drain diode current	T _A = 25 °C	I _S	3.4 ^{b, c}		
Single pulse avalanche current $T_A = 2$		I _{AS}	10		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	5	mJ	
	T _C = 25 °C		17		
Maximum power dissipation	T _C = 70 °C	P _D	11	W	
	T _A = 25 °C	ГD	3.8 ^{b, c}	vv	
	T _A = 70 °C		2.4 ^{b, c}]	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260	C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SMYBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{b, f}	t ≤ 10 s	R _{thJA}	25	33	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	5.5	7.2	C/W

Notes a. Based on T_C = 25 $^\circ C$

b. Surface mounted on 1" x 1" FR4 board

t = 10 s c.

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 70 °C/W e.

f.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	<u> </u>				I	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	
Drain-source breakdown voltage ^(c) (transient)	V _{DSt}	V_{GS} = 0 V, $I_{D(aval)}$ = 20 A, $t_{transcient} \leq 50 \text{ ns}$	36	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	17	-	1.10
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.4	-	mV/°(
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.2	-	2.4	V
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +20, -16 V	-	-	± 100	nA
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	+
Zero gate voltage drain current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$	-	-	10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30	-	-	А
		$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	0.00550	0.00683	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	0.00830	0.01050	Ω
Forward transconductance ^a	g _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	42	-	S
Dynamic ^b	0.0		•			
Input capacitance	C _{iss}		-	680	-	
Output capacitance	C _{oss}	s Voo = 15 V. Voo = 0 V. f = 1 MHz -		266	-	pF
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	54	-	р.
C _{rss} /C _{iss} ratio	- 135		-	0.08	0.16	
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	12.2	19	
Total gate charge	Qg		-	6.2	9.5	nC
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	2.3	-	
Gate-drain charge	Q _{gd}	$V_{DS} = 15 V, V_{GS} = 4.5 V, I_D = 10 A$		2.3	-	1
Output charge	Q _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}$	-	7	-	-
Gate resistance	R _g	f = 1 MHz	0.3	1.5	3	Ω
Turn-on delay time	t _{d(on)}		-	8	15	
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	5	10	
Turn-off delay time	t _{d(off)}	$V_{DD} = 13 \text{ V}, \text{ R}_{\text{L}} = 1.3 \Omega_{\text{Z}}$ $I_{\text{D}} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	15	30	
Fall time	t _f		-	5	10	
Turn-on delay time	t _{d(on)}		-	12	25	ns
Rise time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	55	110	
Turn-off delay time	t _{d(off)}	$V_{DD} = 13 \text{ V}, \text{ H}_{L} = 1.3 \Omega_{2}$ $I_{D} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ H}_{\text{g}} = 1 \Omega$	-	15	30	1
Fall time	t _f		_	12	25	
Drain-Source Body Diode Characteristi			1	=		
Continuous source-drain diode current	Is	T _C = 25 °C	- 1	-	16	
Pulse diode forward current ^a	I _{SM}		-	-	90	Α
Body diode voltage	V _{SD}	I _S = 5 A	-	0.8	1.1	V
Body diode reverse recovery time	t _{rr}		-	15	30	ns
Body diode reverse recovery charge	Q _{rr}	L = 5 A di/dt = 100 A/up	-	5	10	nC
Reverse recovery fall time	t _a	I _F = 5 A, di/dt = 100 A/μs, T _J = 25 °C		7	-	10
Reverse recovery rise time	t _b	~	-	8		ns

Notes

a. Pulse test: pulse width $\leq 300~\mu\text{s},\,duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Based on characterization, not subject to production testing

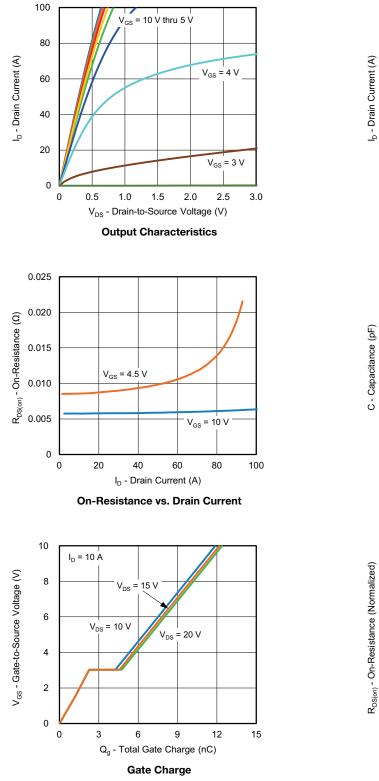
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

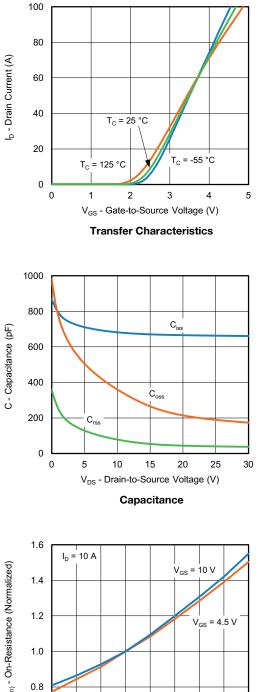
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





On-Resistance vs. Junction Temperature

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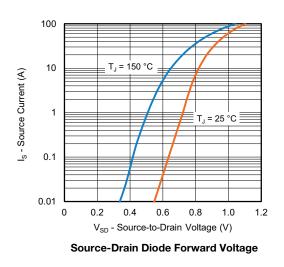
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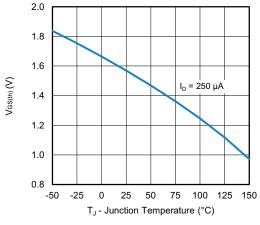
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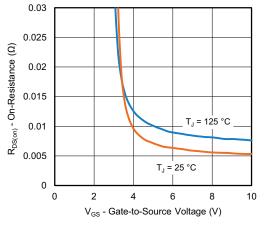
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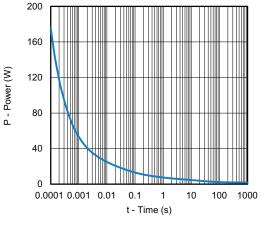




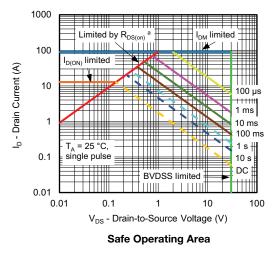




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Note

a. V_{GS} > minimum VGS at which R_{DS(on)} is specified

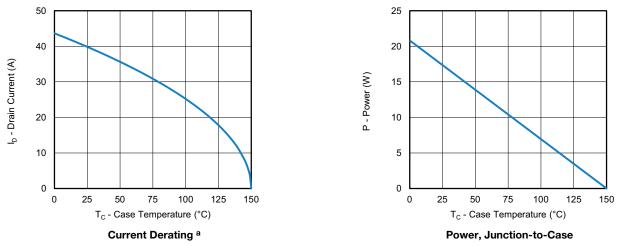
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



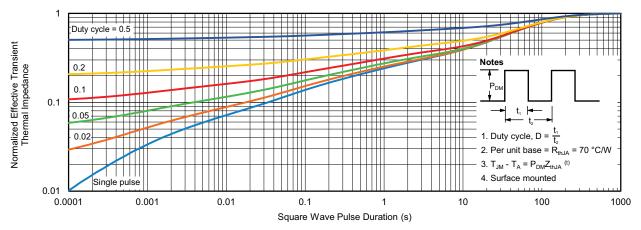


a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

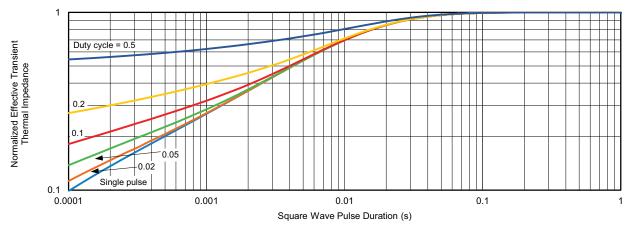


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

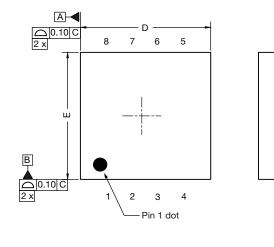
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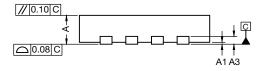
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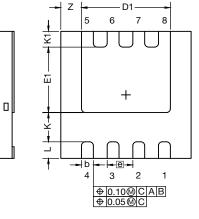


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Case Outline for PowerPAK® 1212-SWLH







DIM.		MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	MIN. NOM.		
А	0.82	0.90	0.98	0.032	0.035	0.038	
A1	0.00	-	0.05	0.000	-	0.002	
A3		0.20 ref.			0.008 ref.		
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е	0.65 bsc.			0.026 bsc.			
к	0.76 ref.			0.030 ref.			
K1	0.41 ref.			0.016 ref.			
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.			0.021 ref.			
I: C20-0863-F	lev. B, 20-Jul-2020			1			



RECOMMENDED MINIMUM PADS FOR PowerPAK[®] 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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